

P-Channel 30-V (D-S) MOSFET

Key Features:

- Low $r_{DS(on)}$ trench technology
- Low thermal impedance
- Fast switching speed

Typical Applications:

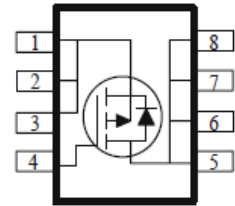
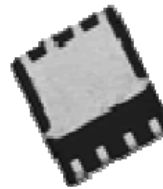
- White LED boost converters
- Automotive Systems
- Industrial DC/DC Conversion Circuits

PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (m Ω)	I_D (A)
-30	5.8 @ $V_{GS} = -10V$	24
	7.6 @ $V_{GS} = -4.5V$	21



RoHS
COMPLIANT
HALOGEN
FREE

DFN5X6-8L



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter		Symbol	Limit	Units
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current ^a	$T_A = 25^\circ\text{C}$	I_D	24	A
	$T_A = 70^\circ\text{C}$		19.2	
Pulsed Drain Current ^b		I_{DM}	-100	
Continuous Source Current (Diode Conduction) ^a		I_S	-2.1	A
Power Dissipation ^a	$T_A = 25^\circ\text{C}$	P_D	5	W
	$T_A = 70^\circ\text{C}$		3.2	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Maximum	Units
Maximum Junction-to-Ambient ^a	$t \leq 10 \text{ sec}$	$R_{\theta JA}$	25	$^\circ\text{C/W}$
	Steady State		65	

Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

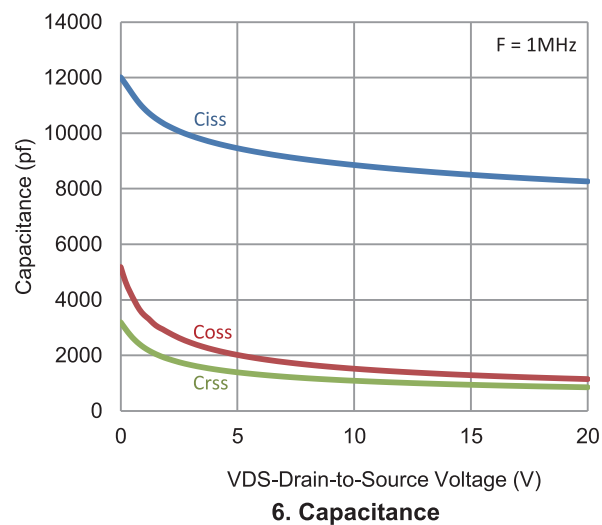
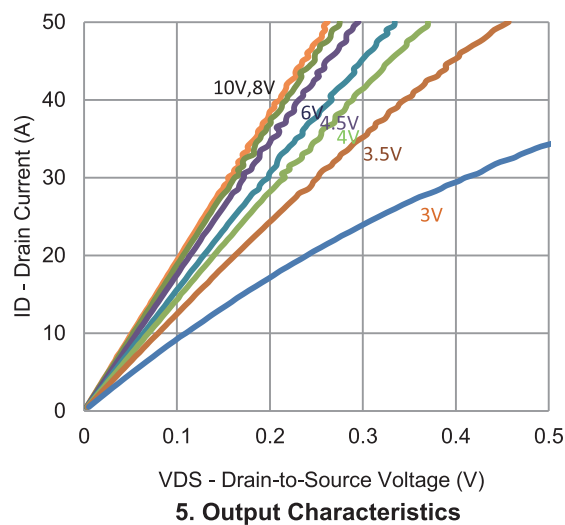
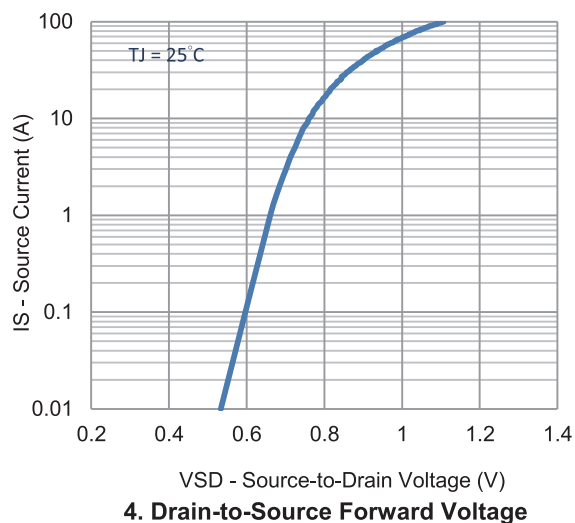
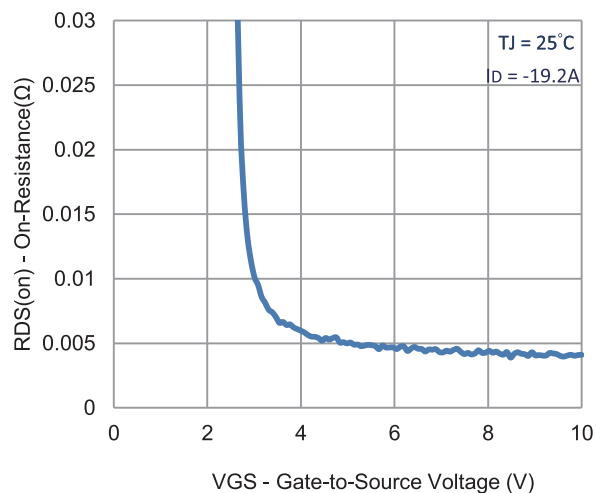
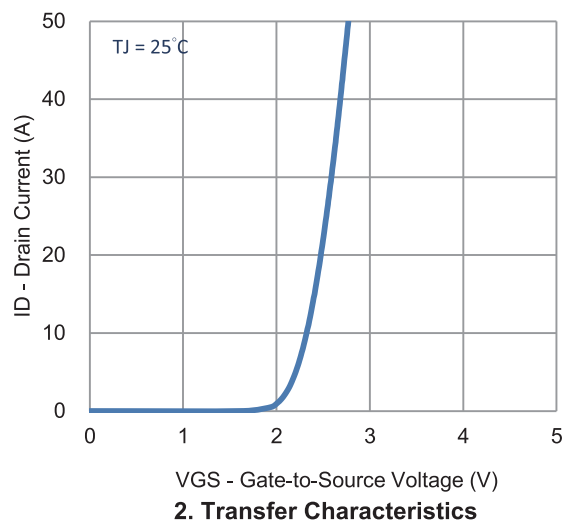
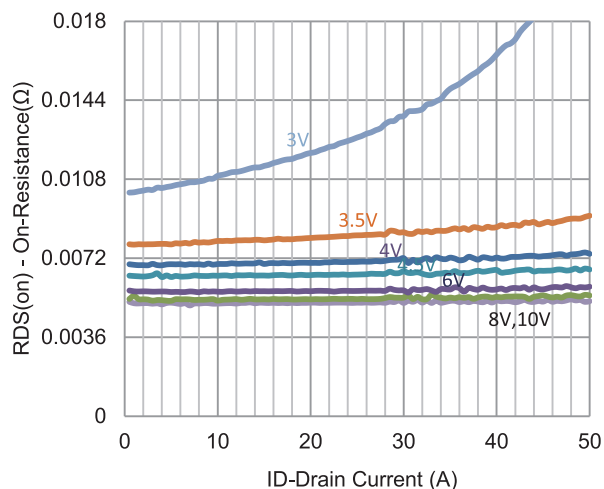
Electrical Characteristics

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24 V, V_{GS} = 0 V$			-1	μA
		$V_{DS} = -24 V, V_{GS} = 0 V, T_J = 55^\circ C$			-25	
On-State Drain Current	$I_{D(on)}$	$V_{DS} = -5 V, V_{GS} = -10 V$	-50			A
Drain-Source On-Resistance	$r_{DS(on)}$	$V_{GS} = -10 V, I_D = -19.2 A$			5.8	m Ω
		$V_{GS} = -4.5 V, I_D = 16.8 A$			7.6	
Forward Transconductance	g_{fs}	$V_{DS} = -15 V, I_D = -19.2 A$		30		S
Diode Forward Voltage	V_{SD}	$I_S = -1.1 A, V_{GS} = 0 V$		-0.69		V
Dynamic						
Total Gate Charge	Q_g	$V_{DS} = -15 V, V_{GS} = -4.5 V,$ $I_D = -19.2 A$		120		nC
Gate-Source Charge	Q_{gs}			36		
Gate-Drain Charge	Q_{gd}			51		
Turn-On Delay Time	$t_{d(on)}$	$V_{DS} = -15 V, R_L = 0.8 \Omega,$ $I_D = -19.2 A,$ $V_{GEN} = -10 V, R_{GEN} = 6 \Omega$		18		ns
Rise Time	t_r			121		
Turn-Off Delay Time	$t_{d(off)}$			319		
Fall Time	t_f			202		
Input Capacitance	C_{iss}	$V_{DS} = -15 V, V_{GS} = 0 V, f = 1 MHz$		8500		pF
Output Capacitance	C_{oss}			1287		
Reverse Transfer Capacitance	C_{rss}			940		

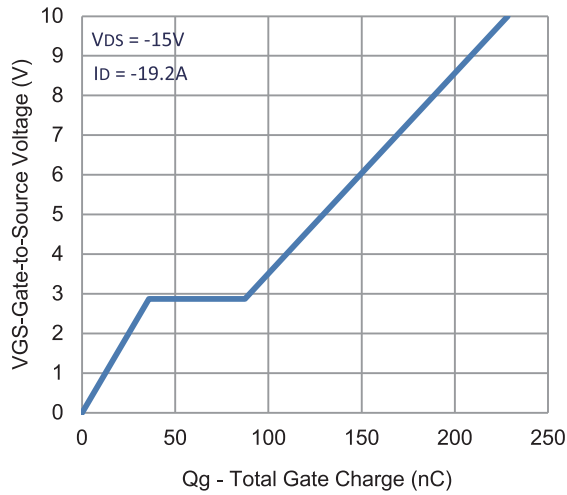
Notes

- Pulse test: PW $\leq 300 \mu s$ duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.

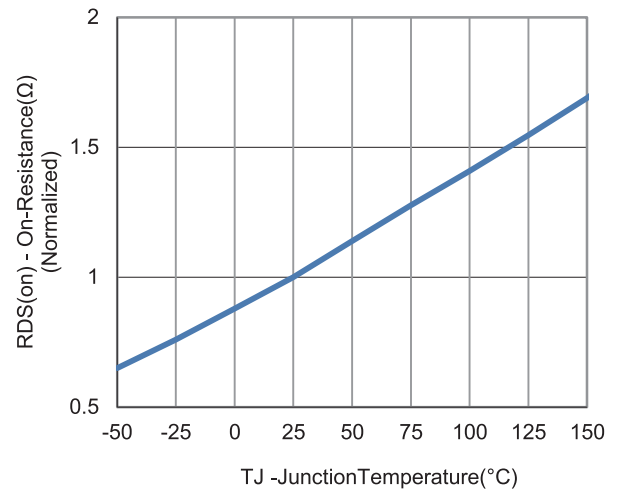
Typical Electrical Characteristics



Typical Electrical Characteristics

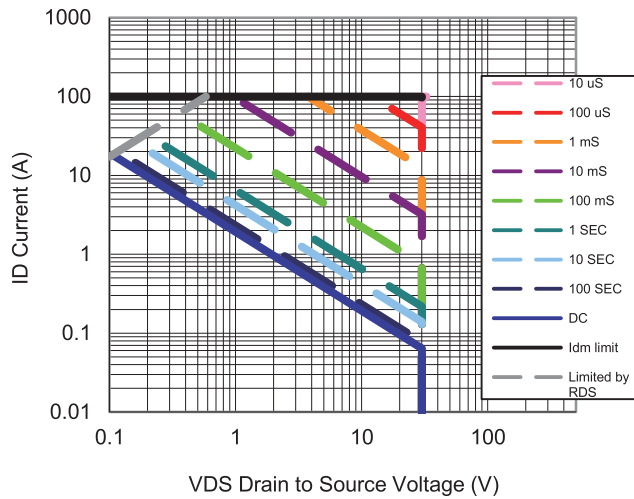


7. Gate Charge

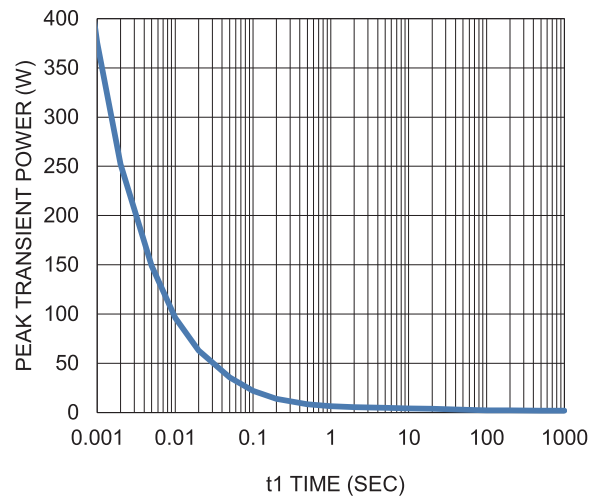


8. Normalized On-Resistance Vs Junction Temperature

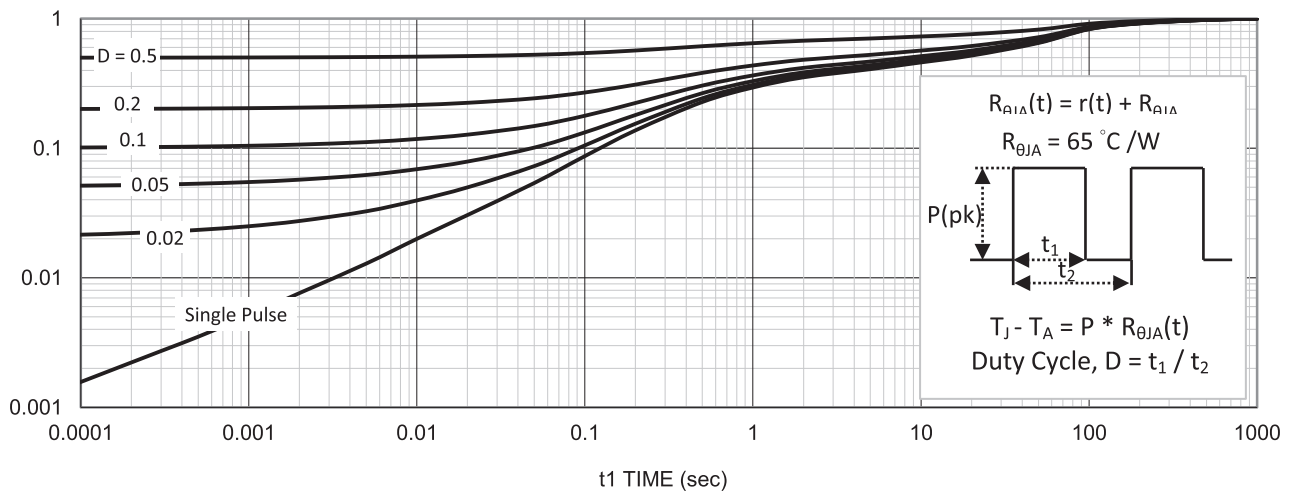
$I_D = 2.3A$



9. Safe Operating Area

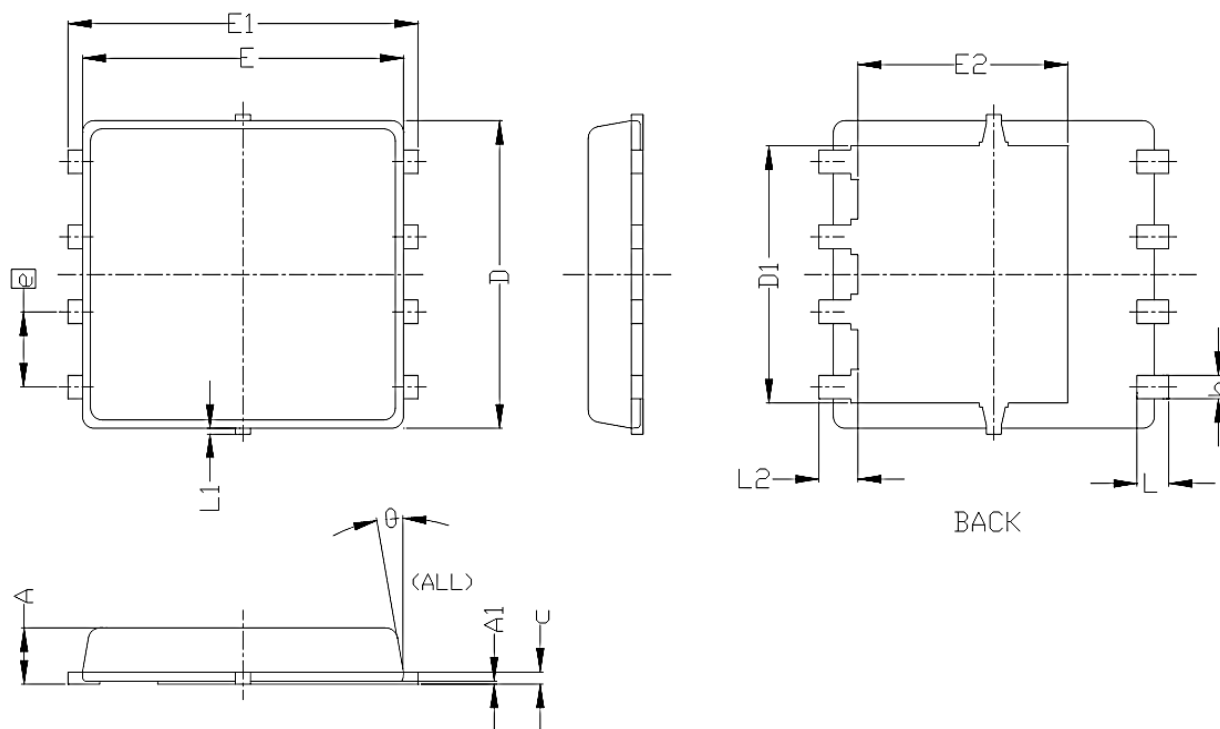


10. Single Pulse Maximum Power Dissipation



11. Normalized Thermal Transient Junction to Ambient

Package Information



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.85	0.95	1.00	0.033	0.037	0.039
A1	0.00	---	0.05	0.000	---	0.002
b	0.30	0.40	0.50	0.012	0.016	0.020
c	0.15	0.20	0.25	0.006	0.008	0.010
D	5.20 BSC			0.205 BSC		
D1	4.35 BSC			0.171 BSC		
E	5.55 BSC			0.219 BSC		
E1	6.05 BSC			0.238 BSC		
E2	3.62 BSC			0.143 BSC		
e	1.27 BSC			0.050 BSC		
L	0.45	0.55	0.65	0.018	0.022	0.026
L1	0	---	0.15	0	---	0.006
L2	0.68 REF			0.027 REF		
θ	0°	---	10°	0°	---	10°